

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	IRFP90N20DPBF	**Issued**	21. July 2021
MA#	MA005539521		
Package	PG-TO247-3-901	**Weight***	5744.42 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	34.771	0.61	0.61	6053	6053
leadframe	inorganic material	phosphorus	7723-14-0	1.131	0.02		197	
	non noble metal	iron	7439-89-6	3.771	0.07		656	
	non noble metal	copper	7440-50-8	3,765.728	65.53	65.62	655545	656398
wire	non noble metal	aluminium	7429-90-5	10.114	0.18	0.18	1761	1761
encapsulation	organic material	carbon black	1333-86-4	9.488	0.17		1652	
	plastics	epoxy resin	-	379.531	6.61		66070	
	inorganic material	silicondioxide	60676-86-0	1,508.636	26.26	33.04	262627	330349
leadfinish	non noble metal	tin	7440-31-5	13.948	0.24	0.24	2428	2428
solder	non noble metal	tin	7440-31-5	0.346	0.01		60	
	noble metal	silver	7440-22-4	0.433	0.01		75	
	non noble metal	lead	7439-92-1	16.523	0.29	0.31	2876	3011
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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